



ASSEMBLY NOTES:

Built on PMP7188 Rev_A PCB

Ref. Des. > 99 have been added

Disconnect TP5 & R9 from cathode of D2 and connect to TP3



Title		
184V...265Vac to 12V @ 2A		
Size	Number	Rev
B	PMP7188	B
Date	7/27/2012	Drawn by R. Scibilia
Filename	PMP7188 Rev_B_pads.sch	Sheet 1 of 1

Engineer R. Scibilia

7/27/2012

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